Onsemi

MOSFET - Power, Single N-Channel, STD Gate, SO8FL

80 V, 4.5 mΩ, 92 A NVMFWS4D5N08X

Features

- Low Q_{RR}, Soft Recovery Body Diode
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Synchronous Rectification (SR) in DC-DC and AC-DC
- Primary Switch in Isolated DC-DC Converter
- Motor Drives
- Automotive 48 V System

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

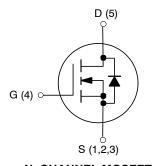
Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V _{DSS}	80	V
Gate-to-Source Voltage		V _{GS}	±20	V
Continuous Drain Current (Note 1)	$T_C = 25^{\circ}C$	۱ _D	92	А
	$T_{C} = 100^{\circ}C$		65	
Power Dissipation (Note 1)	$T_C = 25^{\circ}C$	PD	82	W
Pulsed Drain Current	T _C = 25°C,	I _{DM} 350		А
Pulsed Source Current (Body Diode)	t _P = 100 μs	I _{SM}	350	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)		I _S	126	А
Single Pulse Avalanche Energy (Note 3) (I _{PK} = 35 A)		E _{AS}	61	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using a 1 in2, 1 oz. Cu pad

- 2. The entire application environment impacts the thermal resistance values shown,
- they are not constants and are only valid for the particular conditions noted. 3. E_{AS} of 61 mJ is based on started $T_J = 25^{\circ}$ C, $I_{AS} = 35$ A, $V_{DD} = 64$ V, $V_{GS} =$ 10 V, 100% avalanche tested

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
80 V	4.5 m Ω @ 10 V	92 A



N-CHANNEL MOSFET



(SO8FL WF) CASE 507BA



4D5N8W = Specific Device Code

= Assembly Location

= Year

А Y

w

- = Work Week
- ΖZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping [†]
NVMFWS4D5N08XT1G	DFNW5 (Pb–Free)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Parameter		Value	Unit
Thermal Resistance, Junction-to-Case (Note 5)	$R_{\theta JC}$	1.83	°C/W
Thermal Resistance, Junction-to-Ambient (Notes 4, 5)	$R_{\theta JA}$	39	

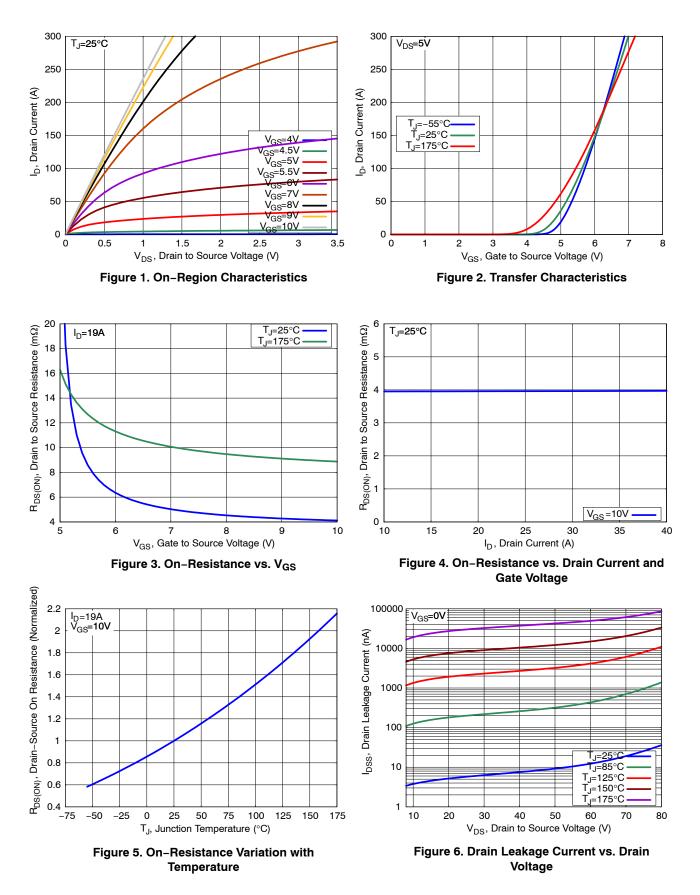
4. Surface–mounted on FR4 board using 1 in² pad, 1 oz. Cu. 5. $R_{\theta JA}$ is determined by the user's board design.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

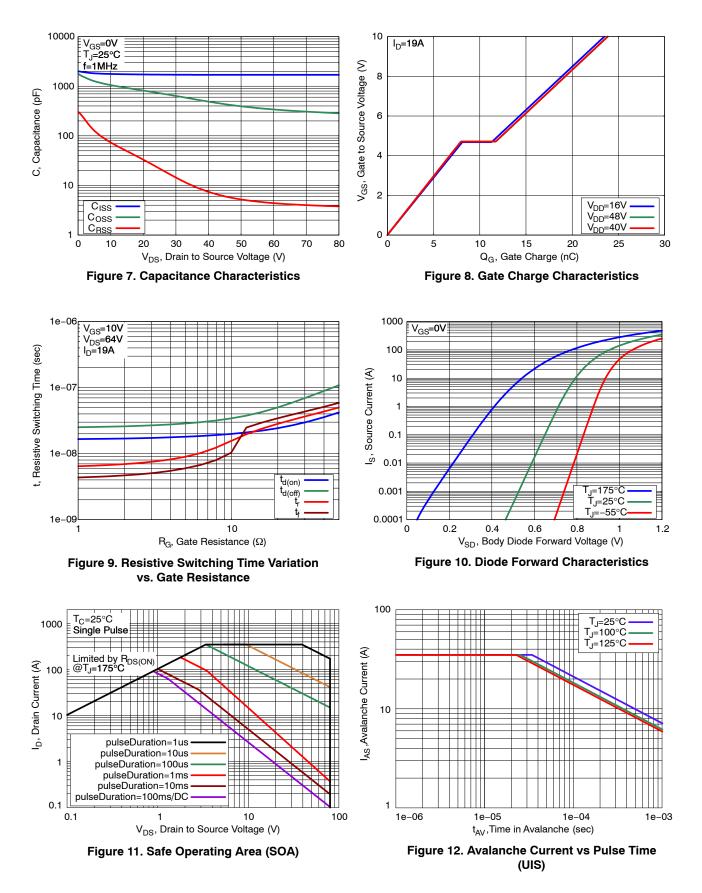
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS			•	•		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 1 mA$	80			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}/ \Delta T_J$	I_D = 1 mA, Referenced to 25°C		31.7		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 80 \text{ V}, \text{ T}_{\text{J}} = 25^{\circ}\text{C}$			1	μΑ
		$V_{DS} = 80 \text{ V}, \text{ T}_{J} = 125^{\circ}\text{C}$			250	
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I_{D} = 19 A		4.0	4.5	mΩ
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_D = 96 \ \mu A$	2.4		3.6	V
Gate Threshold Voltage Temperature Coefficient	$\Delta V_{GS(th)}/\Delta T_J$	$V_{GS} = V_{DS}, \ I_D = 96 \ \mu A$		-7.5		mV/°C
Forward Transconductance	9 _{FS}	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 19 \text{ A}$		61		S
CHARGES, CAPACITANCES & GATE	RESISTANCE					
Input Capacitance	C _{ISS}	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		1700		pF
Output Capacitance	C _{OSS}	f = 1 Mhz		490		
Reverse Transfer Capacitance	C _{RSS}			7		
Output Charge	Q _{OSS}			35		
Total Gate Charge	Q _{G(tot)}	V_{DD} = 40 V, I_D = 19 A, V_{GS} = 10 V		24		nC
Threshold Gate Charge	Q _{G(th)}			5		
Gate-to-Source Charge	Q _{GS}			8		
Gate-to-Drain Charge	Q _{GD}			4		
Gate Plateau Voltage	V _{GP}			4.7		V
Gate Resistance	R _G	f = 1 Mhz		1.45		Ω
SWITCHING CHARACTERISTICS	· · · · · ·					
Turn-On Delay Time	t _{d(on)}	Resistive Load V _{GS} = 0/10 V, V _{DD} = 64 V, I _D = 19 A, R _G = 2.5 Ω		18		ns
Rise Time	tr			7		-
Turn-Off Delay Time	t _{d(off)}			27		
Fall Time	t _f			5		
SOURCE-TO-DRAIN DIODE CHARA	CTERISTICS					
Forward Diode Voltage	V _{SD}	V_{GS} = 0 V, I_{SD} = 19 A, T_J = 25°C		0.82	1.2	V
		V_{GS} = 0 V, I_{SD} = 19 A, T_{J} = 125°C		0.67		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, I _{SD} = 19 A, dI/dt = 1000 A/μs, V _{DD} = 64 V		20		ns
Charge Time	T _A			10]
Discharge Time	Τ _B			10		
Reverse Recovery Charge	Q _{RR}			104	1	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

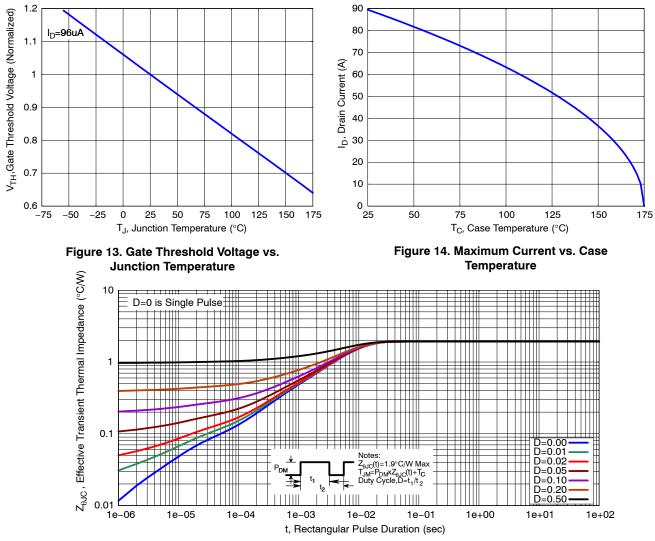
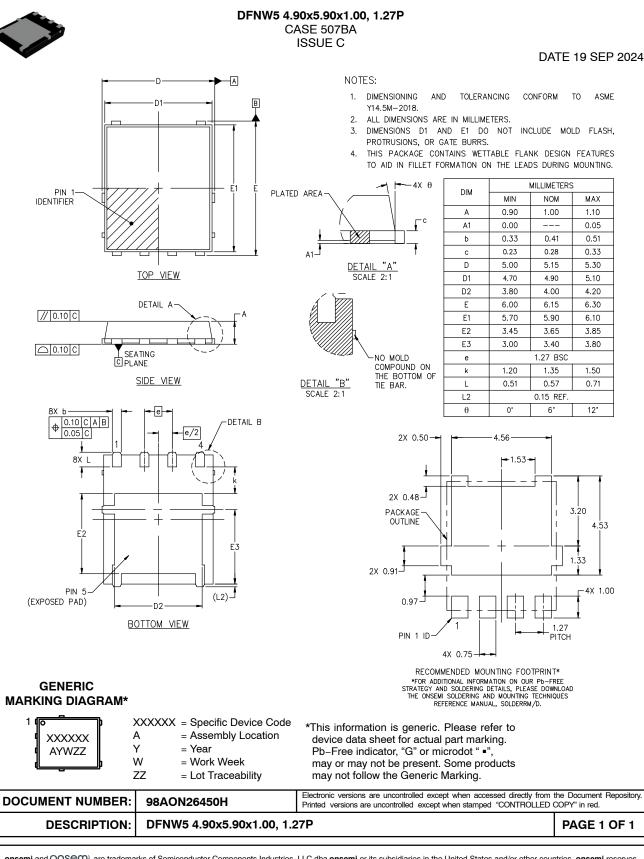


Figure 15. Transient Thermal Response





onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>